



DS1135

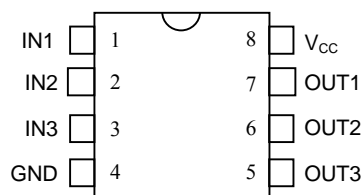
3-in-1 High-Speed Silicon Delay Line

www.dalsemi.com

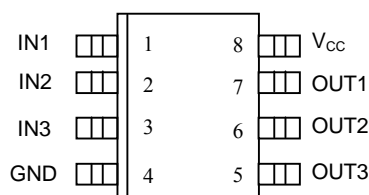
FEATURES

- All-silicon timing circuit
- Three independent buffered delays
- Stable and precise over temperature and voltage
- Leading and trailing edge precision preserves the input symmetry
- Standard 8-pin DIP and 8-pin SOIC (150 mil)
- Vapor phasing, IR and wave solderable
- Available in Tape and Reel
- Commercial and industrial temperature ranges available; see order info table
- 5V operation (for 3V operation, see part number DS1135L)
- Recommended replacement for DS1013 and DS1035

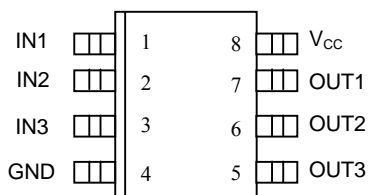
PIN ASSIGNMENT



DS1135M 8-Pin DIP



DS1135Z 8-Pin SOIC (150 mil)



DS1135U 8-Pin 118-mil uSOP

PIN DESCRIPTION

| | |
|-----------------|------------------|
| IN1-IN3 | - Input Signals |
| OUT1-OUT3 | - Output Signals |
| V _{CC} | - +5V Supply |
| GND | - Ground |

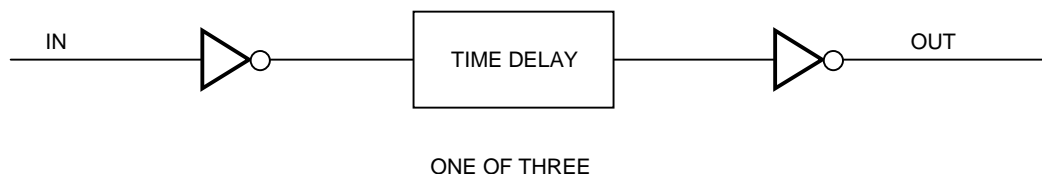
DESCRIPTION

The DS1135 series is a low-power, +5-volt high-speed version of the popular DS1013 and DS1035.

The DS1135 series of delay lines have three independent logic buffered delays in a single package. The device is Dallas Semiconductor's fastest 3-in-1 delay line. It is available in a standard 8-pin DIP and 150 mil 8-pin Mini-SOIC, as well as an 8-pin, 118 mil uSOP.

The device features precise leading and trailing edge accuracy. It has the inherent reliability of an all-silicon delay line solution. Each output is capable of driving up to 10 LS loads.

Standard delay values are indicated in Table 1. Customers may contact Dallas Semiconductor at (972) 371-4348 for further information on custom delay values.

LOGIC DIAGRAM Figure 1**PART NUMBER DELAY TABLE (t_{PLH} , t_{PHL}) Table 1**

| PART NUMBER | DELAY PER OUTPUT (ns) | INITIAL TOLERANCE (Note 1) | TOLERANCE OVER TEMP AND VOLTAGE (Note 2) | |
|-------------|--------------------------|-------------------------------|---|----------------|
| | | | 0°C to +70°C | -40°C to +85°C |
| DS1135-5 | 5/5/5 | ±1.0 ns | ±1.0 ns | ±1.5 ns |
| DS1135-6 | 6/6/6 | ±1.0 ns | ±1.0 ns | ±1.5 ns |
| DS1135-8 | 8/8/8 | ±1.0 ns | ±1.0 ns | ±1.5 ns |
| DS1135-10 | 10/10/10 | ±1.0 ns | ±1.0 ns | ±1.5 ns |
| DS1135-12 | 12/12/12 | ±1.0 ns | ±1.0 ns | ±1.5 ns |
| DS1135-15 | 15/15/15 | ±1.0 ns | ±1.5 ns | ±2 ns |
| DS1135-20 | 20/20/20 | ±1.0 ns | ±1.5 ns | ±2 ns |
| DS1135-25 | 25/25/25 | ±1.5 ns | ±1.5 ns | ±2 ns |
| DS1135-30 | 30/30/30 | ±1.5 ns | ±1.5 ns | ±2 ns |

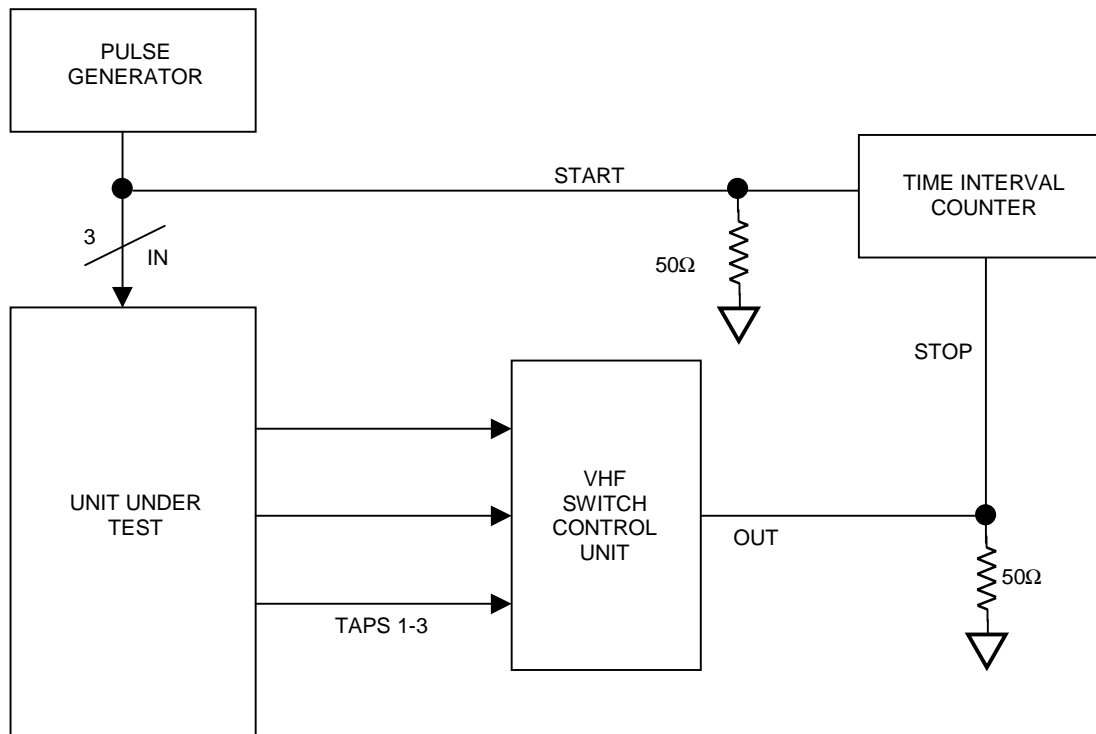
NOTES:

1. Nominal conditions are +25°C and $V_{CC} = +5.0$ volts.
2. Voltage range of 4.75 volts to 5.25 volts.
3. Delay accuracies are for both leading and trailing edges.

TEST SETUP DESCRIPTION

Figure 2 illustrates the hardware configuration used for measuring the timing parameters of the DS1135. The input waveform is produced by a precision pulse generator under software control. Time delays are measured by a time interval counter (20 ps resolution) connected to the output. The DS1135 output taps are selected and connected to the interval counter by a VHF switch control unit. All measurements are fully automated with each instrument controlled by the computer over an IEEE 488 bus.

DS1135 TEST CIRCUIT Figure 2



ABSOLUTE MAXIMUM RATINGS*

| | |
|---------------------------------------|------------------------------|
| Voltage on Any Pin Relative to Ground | -1.0V to +7.0V |
| Operating Temperature | -40°C to +85°C |
| Storage Temperature | -55°C to +125°C |
| Soldering Temperature | See J-STD-020A specification |
| Short Circuit Output Current | 50 mA for 1 second |

* This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

DC ELECTRICAL CHARACTERISTICS (-40°C to +85°C; $V_{CC}=+5V\pm5\%$)

| PARAMETER | SYMBOL | TEST CONDITION | MIN | TYP | MAX | UNITS | NOTES |
|---------------------------|----------|------------------------------------|------|------|--------------|---------|-------|
| Supply Voltage | V_{CC} | | 4.75 | 5.00 | 5.25 | V | 1 |
| Active Current | I_{CC} | $V_{CC}=5.25V$ Period=1 μ s | | | 35 | mA | |
| High Level Input Voltage | V_{IH} | | 2.2 | | $V_{CC}+0.5$ | V | 1 |
| Low Level Input Voltage | V_{IL} | | -0.5 | | 0.8 | V | 1 |
| Input Leakage | I_L | $0V \leq V_I \leq V_{CC}$ | -1.0 | | +1.0 | μ A | |
| High Level Output Current | I_{CC} | $V_{CC}=4.75V$ $V_{OH}=4V$ | | | -1.0 | mA | 1 |
| Low Level Output Current | I_{CC} | $V_{CC}=4.75V$ $V_{OL}=0.5V$ | 12 | | | mA | 1 |

AC ELECTRICAL CHARACTERISTICS (-40°C to +85°C; $V_{CC}=+5V\pm5\%$)

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
|--------------------------|--------------------|-------------------|-----|-----|-------|-------|
| Period | t_{PERIOD} | 2 (t_{WI}) | | | ns | 2 |
| Input Pulse Width | t_{WI} | 100% of Tap Delay | | | ns | 2 |
| Input-to-Output Delay | t_{PLH}, t_{PHL} | See Table 1 | | | ns | |
| Output Rise or Fall Time | t_{OF}, t_{OR} | | 2.0 | 2.5 | ns | |
| Power-up Time | t_{PU} | | | 100 | ms | 3 |

CAPACITANCE ($T_A=25^\circ C$)

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
|-------------------|----------|-----|-----|-----|-------|-------|
| Input Capacitance | C_{IN} | | | 10 | pF | |

TEST CONDITIONS

Ambient Temperature: $25^{\circ}\text{C} \pm 3^{\circ}\text{C}$

Supply Voltage (V_{CC}): $5.0\text{V} \pm 0.1\text{V}$

Input Pulse:

High: $3.0\text{V} \pm 0.1\text{V}$

Low: $0.0\text{V} \pm 0.1\text{V}$

Source Impedance: 50Ω Max.

Rise and Fall Time: 3.0 ns Max. - Measured between 0.6V and 2.4V .

Pulse Width: 500 ns

Pulse Period: $1\text{ }\mu\text{s}$

Output Load Capacitance: 15 pF

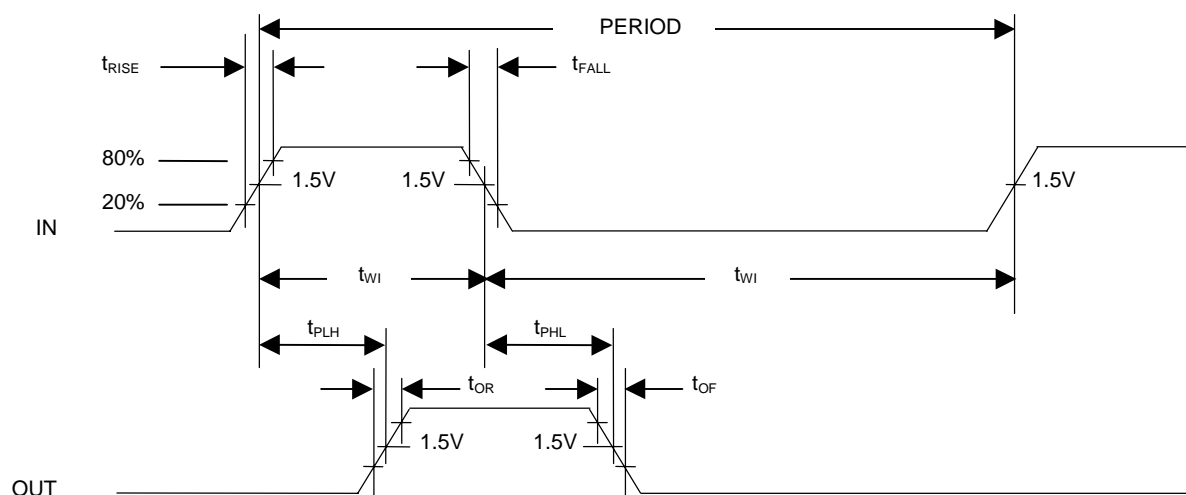
Output: Each output is loaded with the equivalent of one 74F04 input gate.

Data is measured at the 1.5V level on the rising and falling edges.

NOTE:

The above conditions are for test only and do not restrict the devices under other data sheet conditions.

TIMING DIAGRAM



NOTES:

1. All voltages are referenced to ground.
2. Pulse width and duty cycle specifications may be exceeded, however, accuracy will be application sensitive with respect to decoupling, layout, etc.
3. Power-up time is the time from the application of power to the time stable delays are being produced at the output.

